

# MOS FIELD EFFECT TRANSISTOR 2SK3055

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching applications.

#### FEATURES

- Low On-State Resistance  $R_{DS(on)1} = 34 \text{ m}\Omega \text{ MAX.}$  (VGs = 10 V, ID = 15 A)  $R_{DS(on)2} = 50 \text{ m}\Omega \text{ MAX.}$  (VGs = 4.0 V, ID = 15 A)
- Low Ciss : Ciss = 920 pF TYP.
- Built-in Gate Protection Diode
- Isolated TO-220 package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

| VDSS     | 60  | V   |
|----------|---|---|
| VGSS(AC) | ±20   | V   |
| VGSS(DC) | +20, -10  | V   |
| ID(DC)   | ±30   | А   |
| D(pulse) | ±100  | А   |
| Р⊤       | 25  | W   |
| Рт       | 2.0   | W   |
| Tch      | 150   | °C  |
| Tstg     | –55 to +150   | °C  |
| las      | 15  | А   |
| Eas      | 22.5  | mJ  |
|          | VGSS(AC)<br>VGSS(DC)<br>ID(DC)<br>ID(pulse)<br>PT<br>PT<br>Tch<br>Tstg<br>IAS | VGSS(AC)       ±20         VGSS(DC)       +20, -10         ID(DC)       ±30         ID(pulse)       ±100         PT       25         PT       2.0         Tch       150         Tstg       -55 to +150         IAS       15 |

#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %

**2.** Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V

#### THERMAL RESISTANCE

| Channel to Case    | Rth(ch-C) | 5.0  | °C/W |
|--------------------|-----------|------|------|
| Channel to Ambient | Rth(ch-A) | 62.5 | °C/W |

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## ORDERING INFORMATION

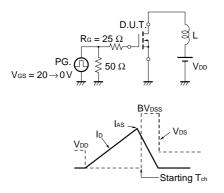
| I | PART NUMBER | PACKAGE         |  |  |
|---|-------------|-----------------|--|--|
|   | 2SK3055     | Isolated TO-220 |  |  |

NEC

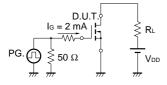
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

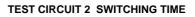
| CHARACTERISTICS                     | SYMBOL          | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|-----------------|---|------|------|------|------|
| Drain to Source On-state Resistance | RDS(on)1        | Vgs = 10 V, Id = 15 A                                     |      | 24   | 34   | mΩ   |
|                                     | RDS(on)2        | Vgs = 4.0 V, Id = 15 A                                    |      | 35   | 50   | mΩ   |
| Gate to Source Cut-off Voltage      | VGS(off)        | Vds = 10 V, Id = 1 mA                                     | 1.0  | 1.6  | 2.0  | V    |
| Forward Transfer Admittance         | <b>y</b> fs     | Vds = 10 V, Id = 15 A                                     | 8.0  | 20   |      | S    |
| Drain Leakage Current               | IDSS            | Vds = 60 V, Vgs = 0 V                                     |      |      | 10   | μA   |
| Gate to Source Leakage Current      | lgss            | $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ |      |      | ±10  | μA   |
| Input Capacitance                   | Ciss            | V <sub>DS</sub> = 10 V                                    |      | 920  |      | pF   |
| Output Capacitance                  | Coss            | Vgs = 0 V   |      | 280  |      | pF   |
| Reverse Transfer Capacitance        | Crss            | f = 1 MHz   |      | 120  |      | pF   |
| Turn-on Delay Time                  | td(on)          | ID = 15 A   |      | 25   |      | ns   |
| Rise Time                           | tr              | VGS(on) = 10 V  |      | 300  |      | ns   |
| Turn-off Delay Time                 | td(off)         | Vdd = 30 V  |      | 70   |      | ns   |
| Fall Time                           | tr              | Rg = 10 Ω   |      | 120  |      | ns   |
| Total Gate Charge                   | QG              | ID = 30 A   |      | 25   |      | nC   |
| Gate to Source Charge               | Q <sub>GS</sub> | V <sub>DD</sub> = 48 V                                    |      | 3.3  |      | nC   |
| Gate to Drain Charge                | Qgd             | $V_{GS(on)} = 10 V$                                       |      | 7.0  |      | nC   |
| Body Diode Forward Voltage          | VF(S-D)         | IF = 30 A, VGS = 0 V                                      |      | 1.0  |      | V    |
| Reverse Recovery Time               | trr             | If = 30 A, V <sub>GS</sub> = 0 V                          |      | 45   |      | ns   |
| Reverse Recovery Charge             | Qrr             | di/dt = 100 A/µs  |      | 60   |      | nC   |

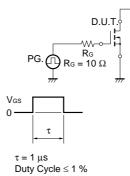
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

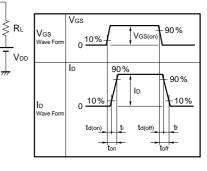


#### **TEST CIRCUIT 3 GATE CHARGE**

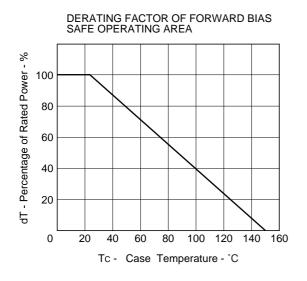




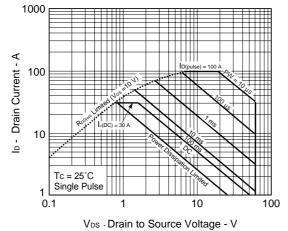




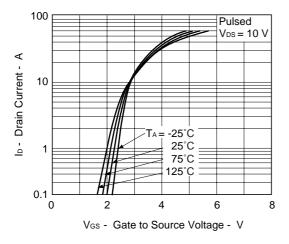
## TYPICAL CHARACTERISTICS (TA = 25 °C)

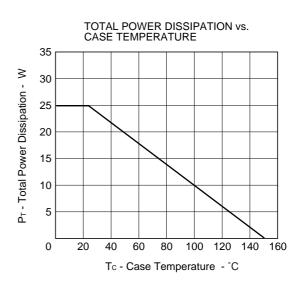




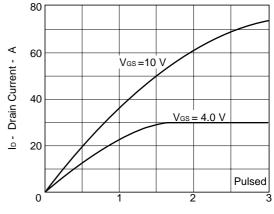


#### FORWARD TRANSFER CHARACTERISTICS

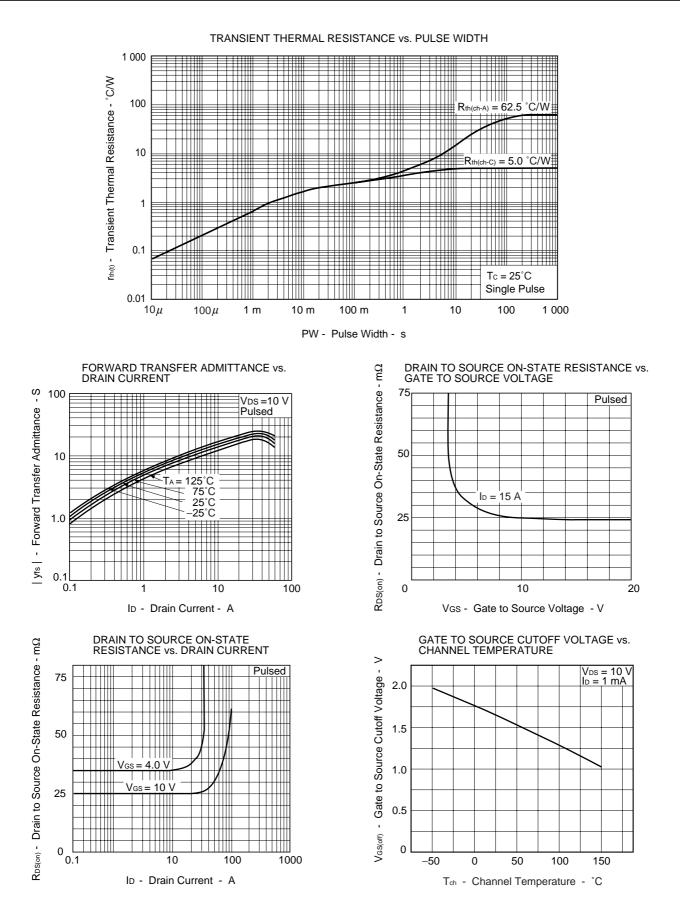




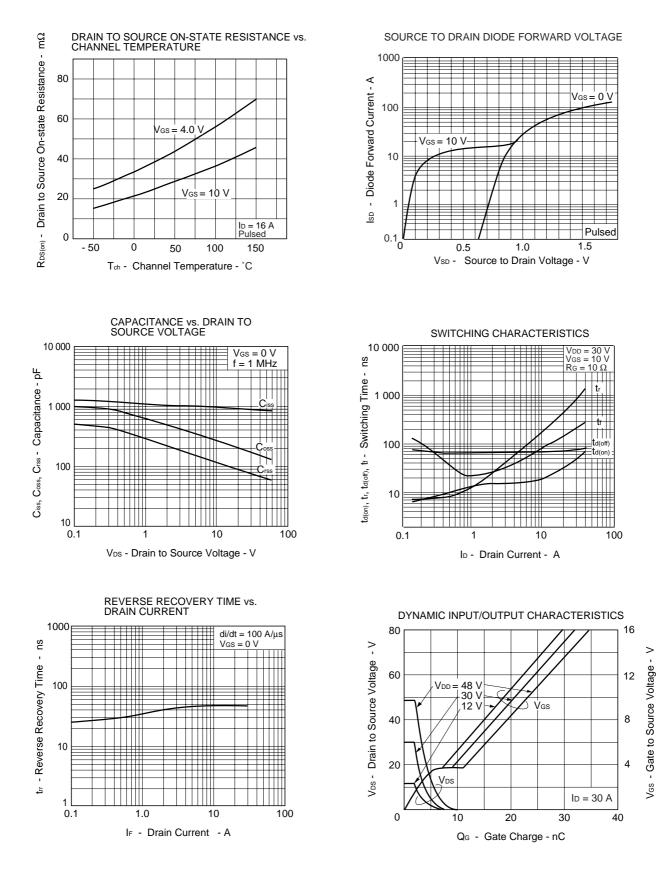




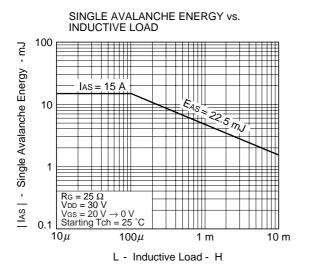
V<sub>DS</sub> - Drain to Source Voltage - V

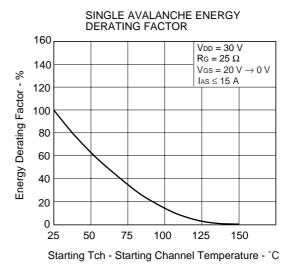


Data Sheet D13094EJ1V0DS00



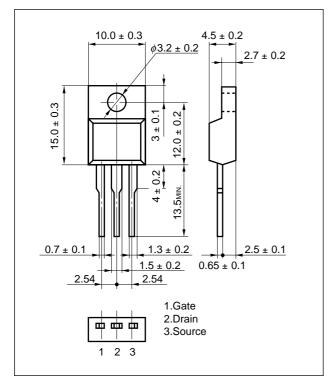
Data Sheet D13094EJ1V0DS00



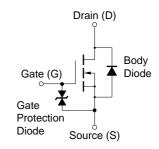


## PACKAGE DRAWING (Unit : mm)

Isolated TO-220 (MP-45F)



**EQUIVALENT CIRCUIT** 



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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